

20 V, P-channel Trench MOSFET

13 October 2020

Product data sheet

1. General description

P-channel enhancement mode Field-Effect Transistor (FET) in a small SOT23 (TO-236AB) Surface-Mounted Device (SMD) plastic package using Trench MOSFET technology.

2. Features and benefits

- · Low threshold voltage
- Extended temperature range T_i = 175 °C
- Trench MOSFET technology
- Very fast switching
- AEC-Q101 qualified

3. Applications

- Relay driver
- High-speed line driver
- High-side load switch
- Switching circuits

4. Quick reference data

Table 1. Quick reference data

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
V _{DS}	drain-source voltage	T _j = 25 °C		-	-	-20	V
V _{GS}	gate-source voltage			-8	-	8	V
I _D	drain current	V _{GS} = -4.5 V; T _{amb} = 25 °C	[1]	-	-	-2.6	А
Static chara	cteristics						
R _{DSon}	drain-source on-state resistance	V _{GS} = -4.5 V; I _D = -2.6 A; T _j = 25 °C		-	97	118	mΩ

[1] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and mounting pad for drain 6 cm².

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5. Pinning information

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	G	gate	3	D
2	S	source		
3	D	drain		G Ling Y
				S 017aaa094

6. Ordering information

Table 3. Ordering information

Type number Package					
	Name	Description	Version		
BSH205G2A		plastic, surface-mounted package; 3 terminals; 1.9 mm pitch; 2.9 mm x 1.3 mm x 1 mm body	SOT23		

7. Marking

Table 4. Marking codes

Type number	Marking code[1]
BSH205G2A	Q8%

[1] % = placeholder for manufacturing site code

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8. Limiting values

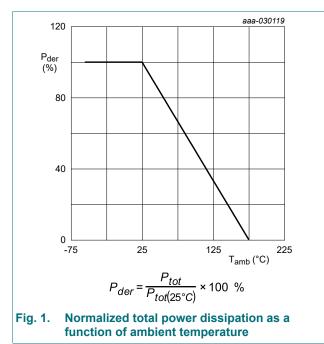
Table 5. Limiting values

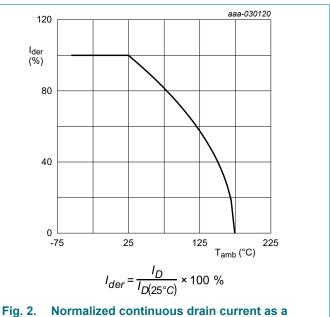
In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions		Min	Max	Unit
V _{DS}	drain-source voltage	T _j = 25 °C		-	-20	V
V _{GS}	gate-source voltage			-8	8	V
I _D	drain current	V _{GS} = -4.5 V; T _{amb} = 25 °C	[1]	-	-2.6	А
		V _{GS} = -4.5 V; T _{amb} = 100 °C	[1]	-	-1.6	А
I _{DM}	peak drain current	T_{amb} = 25 °C; single pulse; $t_p \le 10 \ \mu s$		-	-10	А
P _{tot}	total power dissipation	T _{amb} = 25 °C	[2]	-	610	mW
			[1]	-	1.3	W
		T _{sp} = 25 °C		-	10	W
Tj	junction temperature			-55	175	°C
T _{amb}	ambient temperature			-55	175	°C
T _{stg}	storage temperature			-65	175	°C
Source-drain	n diode					_
I _S	source current	T _{amb} = 25 °C	[1]	-	-1.2	А
Avalanche ru	uggedness					_
E _{DS(AL)S}	non-repetitive drain- source avalanche energy	T _{j(init)} = 25 °C; I _D = -0.5 A; DUT in v avalanche (unclamped)		-	5	mJ

[1] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and mounting pad for drain 6 cm².

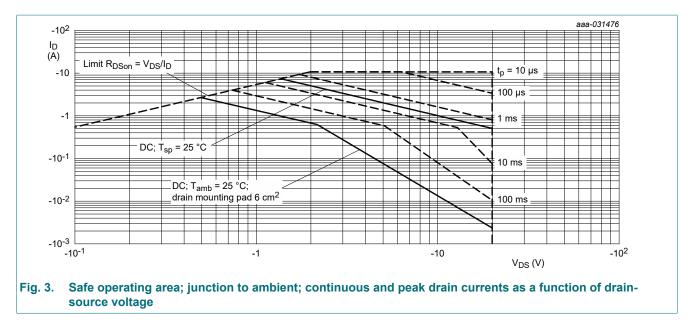
[2] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and standard footprint.







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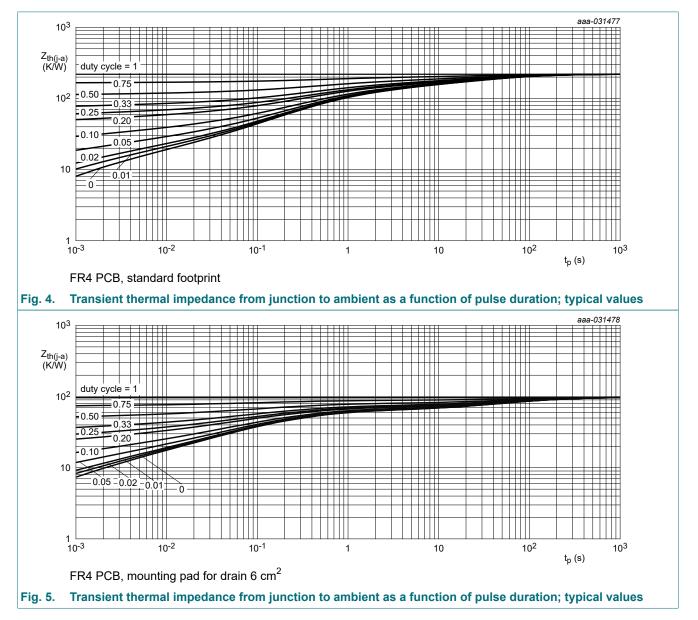


9. Thermal characteristics

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
R _{th(j-a)} thermal resistance from junction to ambient	thermal resistance from	in free air	[1]	-	218	250	K/W
		[2]	-	97	114	K/W	
R _{th(j-sp)}	thermal resistance from junction to solder point			-	10	15	K/W

[1] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.

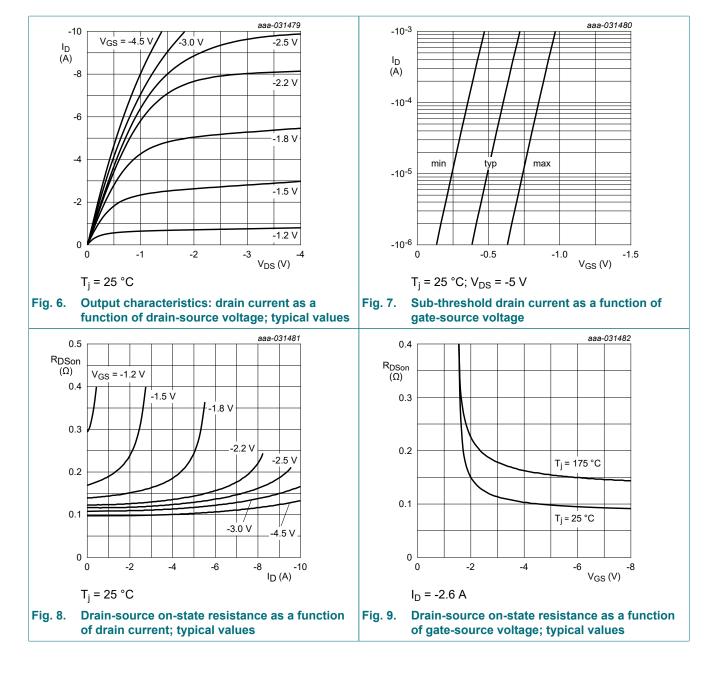
[2] Device mounted on an FR4 PCB, single-sided copper, tin-plated and mounting pad for drain 6 cm².



10. Characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Static chara	octeristics					
V _{(BR)DSS}	drain-source breakdown voltage	I _D = -250 μA; V _{GS} = 0 V; T _j = 25 °C	-20	-	-	V
V _{GSth}	gate-source threshold voltage	I_D = -250 µA; V_{DS} = V_{GS} ; T_j = 25 °C	-0.4	-0.65	-0.9	V
I _{DSS}	drain leakage current	V _{DS} = -20 V; V _{GS} = 0 V; T _j = 25 °C	-	-	-1	μA
I _{GSS}	gate leakage current	V _{GS} = -8 V; V _{DS} = 0 V; T _j = 25 °C	-	-	-100	nA
		V _{GS} = 8 V; V _{DS} = 0 V; T _j = 25 °C	-	-	100	nA
R _{DSon}	drain-source on-state	V _{GS} = -4.5 V; I _D = -2.6 A; T _j = 25 °C	-	97	118	mΩ
	resistance	V _{GS} = -4.5 V; I _D = -2.6 A; T _j = 175 °C	-	153	186	mΩ
		V _{GS} = -2.5 V; I _D = -2.3 A; T _j = 25 °C	-	118	152	mΩ
		V _{GS} = -1.8 V; I _D = -0.5 A; T _j = 25 °C	-	145	240	mΩ
		V _{GS} = -1.5 V; I _D = -0.1 A; T _j = 25 °C	-	170	400	mΩ
9fs	forward transconductance	V _{DS} = -10 V; I _D = -2.6 A; T _j = 25 °C	-	5	-	S
R _G	gate resistance	f = 1 MHz	-	8.3	-	Ω
Dynamic ch	aracteristics	1 1				
Q _{G(tot)}	total gate charge	V _{DS} = -10 V; I _D = -2.6 A; V _{GS} = -4.5 V;	-	4.6	7	nC
Q _{GS}	gate-source charge	T _j = 25 °C	-	0.6	-	nC
Q _{GD}	gate-drain charge	1 –	-	1.2	-	nC
C _{iss}	input capacitance	V _{DS} = -10 V; f = 1 MHz; V _{GS} = 0 V;	-	421	-	pF
C _{oss}	output capacitance	T _j = 25 °C	-	38	-	pF
C _{rss}	reverse transfer capacitance		-	32	-	pF
t _{d(on)}	turn-on delay time	V_{DS} = -10 V; I _D = -2.6 A; V _{GS} = -4.5 V;	-	5	-	ns
t _r	rise time	$R_{G(ext)} = 6 \Omega; T_j = 25 °C$	-	13	-	ns
t _{d(off)}	turn-off delay time	1	-	35	-	ns
t _f	fall time	1 – – – – – – – – – – – – – – – – – – –	-	12	-	ns
Source-drai	n diode	· ·				
V _{SD}	source-drain voltage	I _S = -1.2 A; V _{GS} = 0 V; T _j = 25 °C	-	-0.8	-1.2	V
t _{rr}	reverse recovery time	I _S = -1.1 A; dI _S /dt = 100 A/μs;	-	7	-	ns
Q _r	recovered charge	V _{GS} = 0 V; V _{DS} = -10 V; T _j = 25 °C	-	1	-	nC

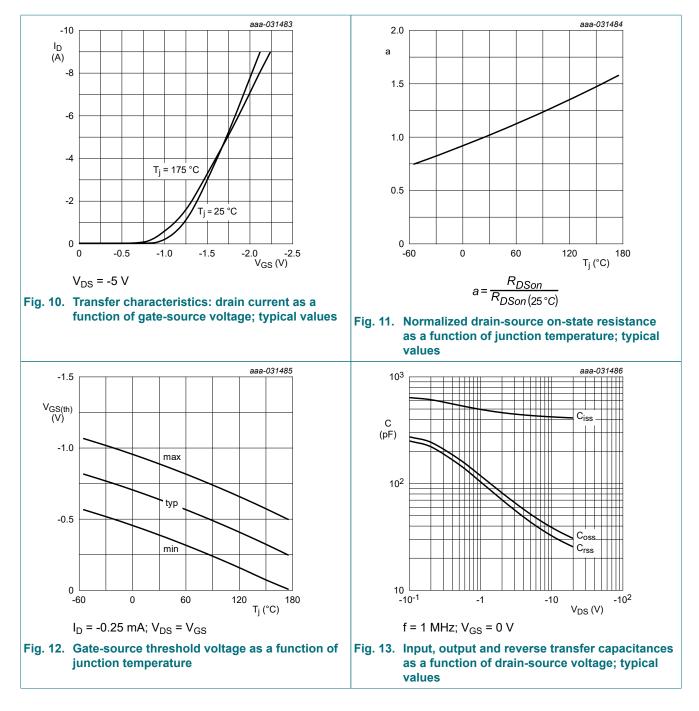
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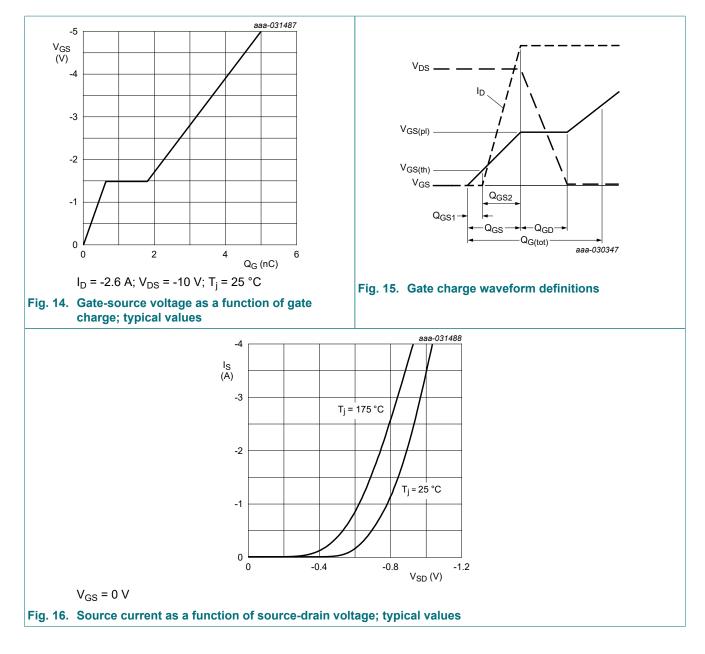
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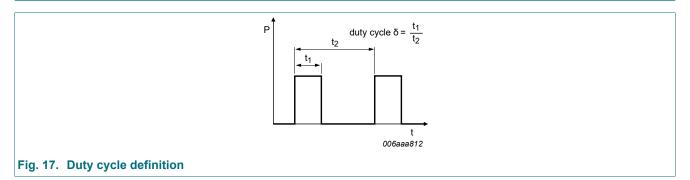


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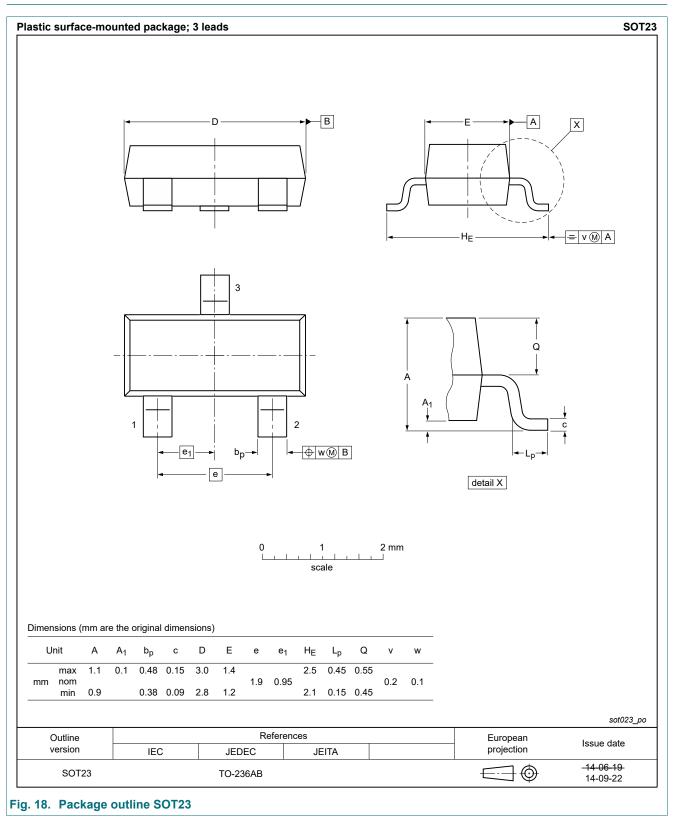
11. Test information



Quality information

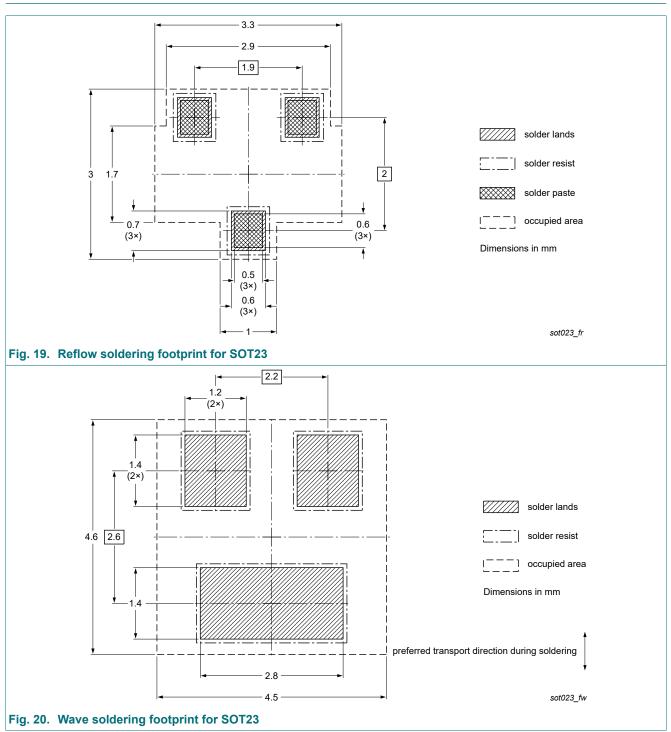
This product has been qualified in accordance with the Automotive Electronics Council (AEC) standard *Q101* - *Stress test qualification for discrete semiconductors*, and is suitable for use in automotive applications.

12. Package outline



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13. Soldering



Product data sheet

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14. Revision history

Table 8. Revision history							
Data sheet ID	Release date	Data sheet status	Change notice	Supersedes			
BSH205G2A v.1	20201013	Product data sheet	-	-			

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15. Legal information

Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

 Please consult the most recently issued document before initiating or completing a design.

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